COMPLIANT

FREE



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Vishay General Semiconductor

Dual Common Cathode Schottky Rectifier



PRIMARY CHARACTERISTICS					
I _{F(AV)}	30 A				
V_{RRM}	45 V				
I _{FSM}	400 A				
V _F	0.47 V				
T _J max.	150 °C				
Package	TO-247AD 3L				
Circuit configuration	Common cathode				

FEATURES

- Power pack
- Guardring for overvoltage protection
- Lower power losses, high efficiency
- Low forward voltage drop
- High forward surge capability
- High frequency operation
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage, high frequency rectifier of switching mode power supplies, freewheeling diodes, DC/DC converters, or polarity protection application.

MECHANICAL DATA

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - RoHS-compliant, halogen-free,

commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked

Mounting Torque: 10 in-lbs maximum

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SD241P	UNIT		
Maximum repetitive peak reverse voltage T _C = 25 °C	V_{RRM}	45	V		
Maximum blocking voltage T _C = 25 °C	V_{DC}	45	V		
Maximum working peak reverse voltage	V_{RWM}	35	V		
Maximum average forward rectified current at T _C = 105 °C	I _{F(AV)}	30	А		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	400	А		
Peak repetitive reverse surge current per diode	I _{RSM} ⁽¹⁾	2.0	Α		
Voltage rate of change V _R = 35 V	dV/dt	10 000	V/µs		
Operating junction temperature range	TJ	-65 to +150	°C		
Storage temperature range	T _{STG}	-65 to +175	°C		

Note

(1) 2.0 μ s pulse width, f = 1.0 kHz

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL TEST CONDITIONS SD241P			UNIT	
Maximum instantaneous forward voltage	V _F ⁽¹⁾	I _F = 10 A	T _C = 25 °C	0.47	- V
		I _F = 20 A	T _C = 125 °C	0.60	
Maximum reverse current at rated V _R	I _R ⁽¹⁾	V _R = 35 V	T _C = 25 °C	1.0	mA
			T _C = 125 °C	100	mA

Note

(1) Pulse test: 300 µs pulse width, 1 % duty cycle



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THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER SYMBOL SD241P U					
Maximum thermal resistance, junction of case per diode	R _{eJC}	1.4	°C/W		

ORDERING INFORMATION (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TO-247AD 3L	SD241P-M3/4P	5.83	Р	25/tube	Tube

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

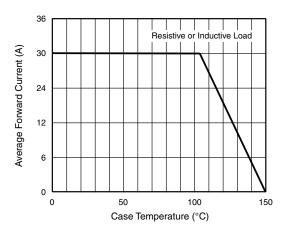


Fig. 1 - Forward Current Derating Curve

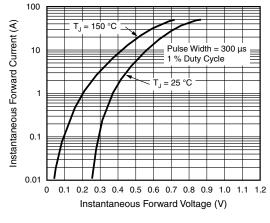


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

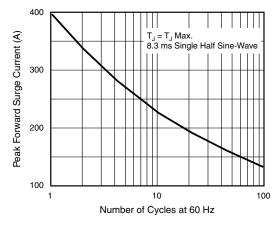


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

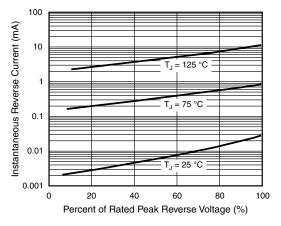


Fig. 4 - Typical Reverse Characteristics Per Diode





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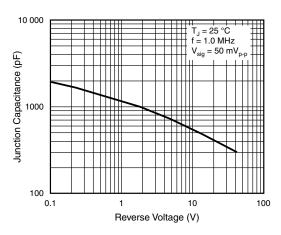


Fig. 5 - Typical Junction Capacitance Per Diode

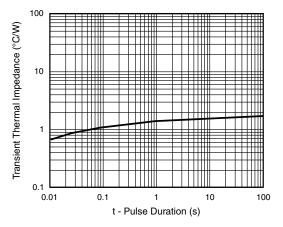
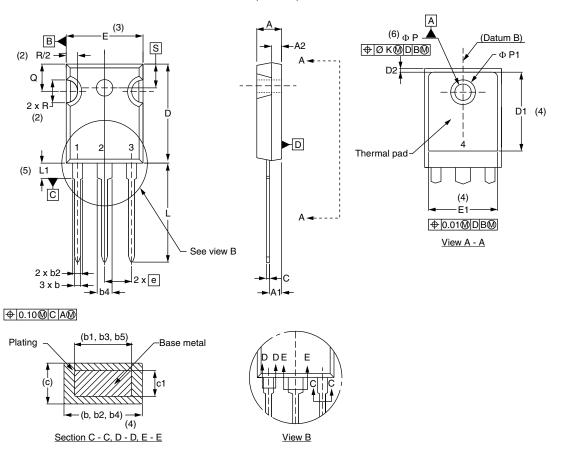


Fig. 6 - Typical Transient Thermal Impedance Per Diode



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PACKAGE OUTLINE DIMENSIONS in millimeters (inches) TO-247AD 3L



SYMBOL	MILLIMETERS		INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.2	254	0.0)10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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